



SURFACE MOUNT HIGH VOLTAGE DUAL SWITCHING DIODE

Features

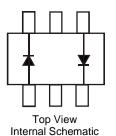
- · Fast Switching Speed
- Surface Mount Package Ideally Suited for Automated Insertion
- High Reverse Breakdown Voltage
- Low Leakage Current
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- PPAP Capable (Note 4)

Mechanical Data

- Case: SOT363
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram
- Terminals: Finish Matte Tin Annealed over Alloy 42
 Leadframe. Solderable per MIL-STD-202, Method 208⁽³⁾
- Weight: 0.003 grams (Approximate)







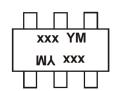
Ordering Information (Note 5)

Part Number	Qualification	Case	Packaging
BAS20DW-7	Commercial	SOT363	3,000/Tape & Reel
BAS20DW-13	Commercial	SOT363	10,000/Tape & Reel
BAS20DWQ-13	Automotive	SOT363	10,000/Tape & Reel
BAS21DW-7	Commercial	SOT363	3,000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. Automotive products are AEC-Q101 qualified and are PPAP capable. Automotive, AEC-Q101 and standard products are electrically and thermally the same, except where specified. For more information, please refer to https://www.diodes.com/quality/product-compliance-definitions/.
- 5. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/

Marking Information



xxx = Product Type Marking Code: BAS20DW Marking: KT2 or KT3 BAS21DW Marking: KT3 YM = Date Code Marking Y = Year (ex: F = 2018) M = Month (ex: 9 = September)

Date Code Key

Year	2005	2006		2018	3 201	9 20)20	2021	2022	2023	2024	2025
Code	S	Т		F	G		Н		7	K	L	М
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	y Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	BAS20DW	BAS21DW	Unit
Repetitive Peak Reverse Voltage	V_{RRM}	200	250	V	
Working Peak Reverse Voltage DC Blocking Voltage	V _{RWM} V _R	150 200		V	
RMS Reverse Voltage	V _{R(RMS)}	106	141	V	
Forward Continuous Current (Note 8)	I _{FM}	400		mA	
Average Rectified Output Current (Note 8)	Io	200		mA	
Non-Repetitive Peak Forward Surge Current	I _{FSM}	2.5 0.5		А	
Repetitive Peak Forward Surge Current	I _{FRM}	625		mA	

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 6)	P _D	200	mW
Thermal Resistance Junction to Ambient Air (Note 6)	R _{0JA}	625	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-65 to +150	°C

Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic			Min	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 7)	BAS20DW BAS21DW	V _{(BR)R}	200 250	_	V	I _R = 100μA
Forward Voltage		V _F	_	1.0 1.25	V	I _F = 100mA I _F = 200mA
Reverse Current @ Rated DC Blocking Voltage (Note 7)		I _R	_	100 15	nΑ μΑ	$T_{J} = +25^{\circ}C$ $T_{J} = +100^{\circ}C$
Total Capacitance		C _T	_	5.0	pF	$V_R = 0$, $f = 1.0MHz$
Reverse Recovery Time		t _{RR}	_	50	ns	$I_F = I_R = 30\text{mA},$ $I_{RR} = 0.1 \text{ x } I_R, R_L = 100\Omega$

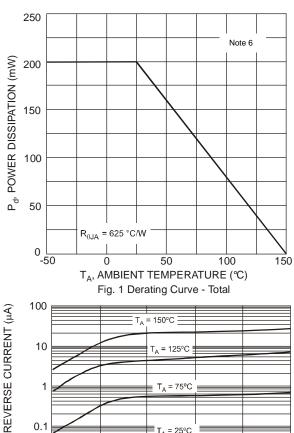
Notes:

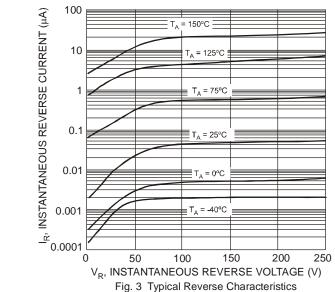
^{6.} Part mounted on FR-4 substrate, 2 oz Cu pad layout board with recommended pad layout, which can be found on our website at http://www.diodes.com/package-outlines.html.

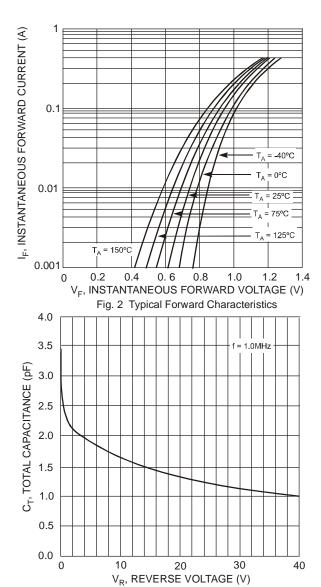
Short duration pulse test used to minimize self-heating effect.

^{8.} Double Diode Loaded in Parallel. For Single Diode or Double Diode Loaded in Series, the continuous forward current should be reduced by half.





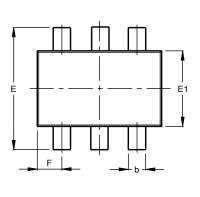


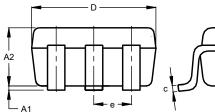




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.





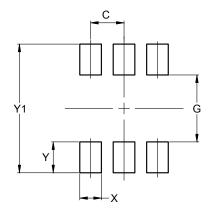
	SOT363						
Dim	Min	Max	Тур				
A1	0.00	0.10	0.05				
A2	0.90	1.00	0.95				
b	0.10	0.30	0.25				
С	0.10	0.22	0.11				
D	1.80	2.20	2.15				
Е	2.00	2.20	2.10				
E1	1.15	1.35	1.30				
е	0.650 BSC						
F	0.40	0.45	0.425				
L	0.25	0.40	0.30				
а	0°	8°					
All I	All Dimensions in mm						

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT363

SOT363



Dimensions	Value (in mm)
С	0.650
G	1.300
X	0.420
Y	0.600
Y1	2.500



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многоканальный

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